



XAA170 Dual Single-Pole, Normally Open OptoMOS® Relay

Parameter	Rating	Units
Blocking Voltage	350	V _P
Load Current	100	mA
Max R _{ON}	50	Ω
Input Control Current	5	mA

Features

- 3750V_{rms} Input/Output Isolation
- Small 8-Pin Package
- Low Drive Power Requirements (TTL/CMOS Compatible)
- · No Moving Parts
- High Reliability
- Arc-Free With No Snubbing Circuits
- FCC Compatible
- VDE Compatible
- No EMI/RFI Generation
- · Machine Insertable, Wave Solderable
- Surface Mount Tape & Reel Version Available

Applications

- Telecommunications
 - Telecom Switching
 - Tip/Ring Circuits
 - Modem Switching (Laptop, Notebook, Pocket Size)
 - Hook Switch
 - Dial Pulsing
 - Ground Start
 - Ringing Injection
- Instrumentation
 - Multiplexers
 - Data Acquisition
 - Electronic Switching
 - I/O Subsystems
 - Meters (Watt-Hour, Water, Gas)
- Medical Equipment-Patient/Equipment Isolation
- Security
- Aerospace
- Industrial Controls

Description

XAA170 is a dual normally open (1-Form-A) solid state relay with two independent, optically coupled relays in a single 8-pin package. Clare's patented OptoMOS architecture makes available the optically coupled technology necessary to activate the output's efficient MOSFET switches while providing a 3750V_{rms} input-to-output isolation barrier. Control of the isolated output is accomplished by means of a highly effective GaAlAs infrared LED at the input.

By incorporating two independent single-pole relays into a single 8-pin package, the XAA170 saves board space by providing a more compact design solution than two discrete single-pole relays in a variety of applications.

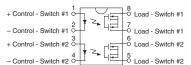
Approvals

- UL Recognized Component: File E76270
- CSA Certified Component: Certificate 1175739
- EN/IEC 60950-1 Compliant

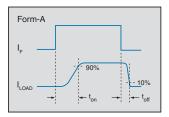
Ordering Information

Part #	Description
XAA170	8-Pin DIP (50/Tube)
XAA170P	8-Pin Flatpack (50/Tube)
XAA170PTR	8-Pin Flatpack T&R (1000/Reel)
XAA170S	8-Pin Surface Mount (50/Tube)
XAA170STR	8-Pin Surface Mount T&R (1000/Reel)

Pin Configuration



Switching Characteristics of Normally Open Devices











Absolute Maximum Ratings @ 25°C

Parameter	Ratings	Units
Blocking Voltage	350	V _P
Reverse Input Voltage	5	V
Input Control Current	50	mA
Peak (10ms)	1	А
Input Power Dissipation ¹	150	mW
Total Power Dissipation ²	800	mW
Isolation Voltage, Input to Output	3750	V _{rms}
Operational Temperature	-40 to +85	°C
Storage Temperature	-40 to +125	°C

the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to

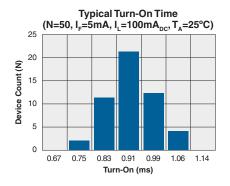
Electrical Characteristics @ 25°C

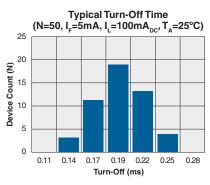
Parameter	Conditions	Symbol	Min	Тур	Max	Units
Output Characteristics						·
Load Current, Continuous	-	IL	-	-	100	mA
Peak Load Current	t=10ms	I _{LPK}	-	-	350	mA
On-Resistance	I _L =100mA	R _{ON}	-	33	50	Ω
Off-State Leakage Current	$V_L=350V_P$	I _{LEAK}	-	-	1	μΑ
Switching Speeds						
Turn-On	I Fm A V 10V	t _{on}	-	-	5	
Turn-Off	$I_F = 5mA, V_L = 10V$	t _{off}	-	-	5	— ms
Output Capacitance	V _L =50V, f=1MHz	C _{OUT}	-	25	-	pF
Input Characteristics	<u>'</u>					'
Input Control Current	I _L = 100mA	I _F	-	-	5	mA
Input Dropout Current	-	-	0.4	0.7	-	mA
Input Voltage Drop	I _F = 5mA	V _F	0.9	1.2	1.4	V
Reverse Input Current	V _R = 5V	I _R	-	-	10	μΑ
Common Characteristics	·	·		1		'
Capacitance Input to Output	-	-	-	3	-	pF

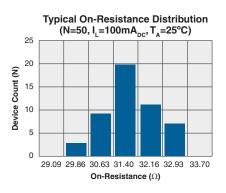
Derate linearly 1.33 mW / °C
 Derate linearly 6.67 mW / °C

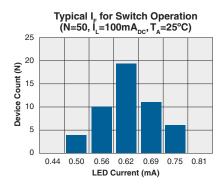


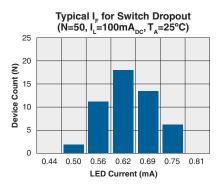
PERFORMANCE DATA*

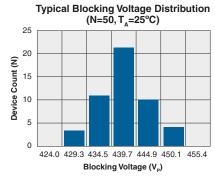


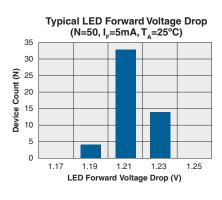


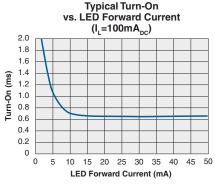


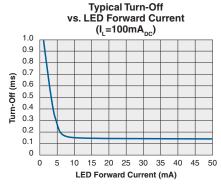


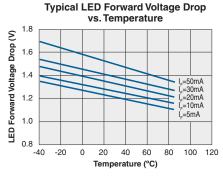


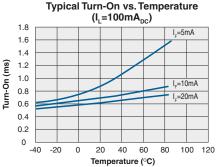


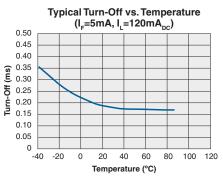












^{*}The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

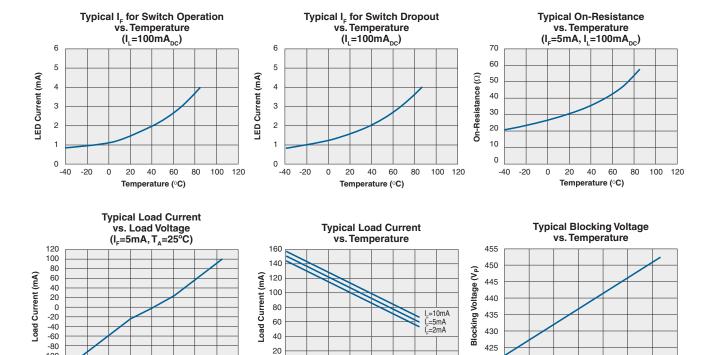


-100

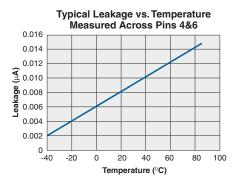
-120

-3

PERFORMANCE DATA*



Temperature (°C)

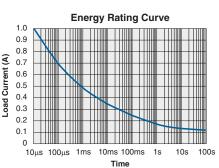


2 3

Load Voltage (V)

0

-40 -20 0 20 40 60 80



420

100 120

-40 -20

20 40 60

Temperature (°C)

80 100

^{*}The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.



Manufacturing Information

Moisture Sensitivity



All plastic encapsulated semiconductor packages are susceptible to moisture ingression. Clare classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to

the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL) rating** as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Rating
XAA170 / XAA170S / XAA170P	MSL 1

ESD Sensitivity



This product is ESD Sensitive, and should be handled according to the industry standard JESD-625.

Reflow Profile

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

Device	Maximum Temperature x Time	
XAA170 / XAA170S	250°C for 30 seconds	
XAA170P	260°C for 30 seconds	

Board Wash

Clare recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable. Since Clare employs the use of silicone coating as an optical waveguide in many of its optically isolated products, the use of a short drying bake could be necessary if a wash is used after solder reflow processes. Chlorine-based or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.



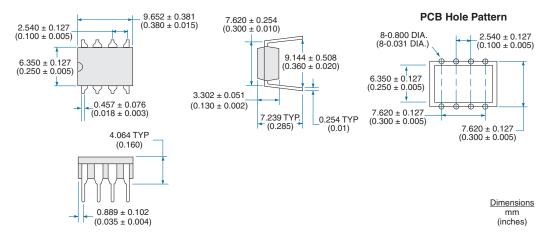




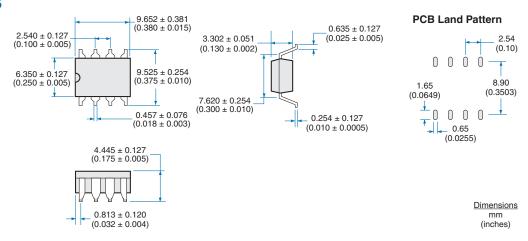


MECHANICAL DIMENSIONS

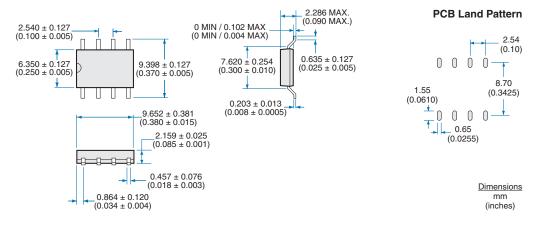
XAA170



XAA170S



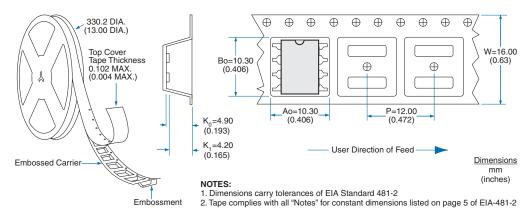
XAA170P



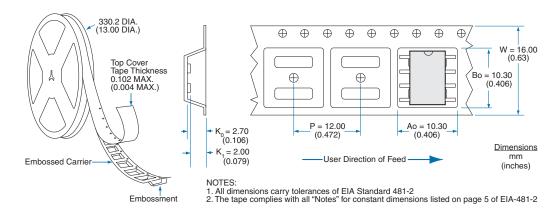


MECHANICAL DIMENSIONS

XAA170S Tape & Reel



XAA170P Tape & Reel



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